PRELIMINARY DATA SHEET

NEC

MOS INTEGRATED CIRCUIT

μPD4416001

16M-BIT CMOS FAST SRAM
16M-WORD BY 1-BIT

Description

The μPD4416001 is a high speed, low power, 16,777,216 bits (16,777,216 words by 1 bits) CMOS static RAM.

Operating supply voltage is 3.3 V ± 0.3 V (A version) or 2.5 V ± 0.125 V (C version).

The μPD4416001 is packaged in a 54-pin plastic TSOP (II).

Features

- 16,777,216 words by 1 bits
- Fast access time : 12, 15 ns (MAX.)
- Output Enable input for easy application

Ordering Information

Part number	Package	Supply voltage	Access time (MAX.)	Supply current (MAX.)	
				At operating	At standby
μPD4416001G5-A12-9JF	54-pin plastic TSOP (II) (400 mil) (Normal bent)	3.3 V ± 0.3 V	12 ns	190 mA	10 mA
μPD4416001G5-A15-9JF			15 ns	150 mA	
μPD4416001G5-C12-9JF		2.5 V ± 0.125 V	12 ns	190 mA	
μPD4416001G5-C15-9JF			15 ns	150 mA	

Document No. M14077EJ1V0DS00 (1st edition)
Date Published June 1999 NS CP(K)
Printed in Japan

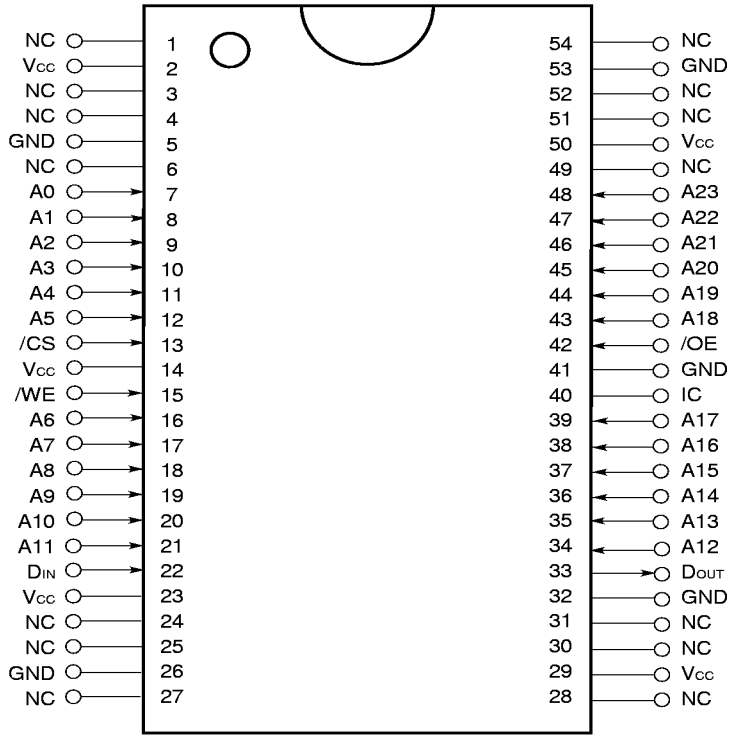
The mark ★ shows major revised points.

Pin Configuration (Marking Side)

/xxx indicates active low signal.

54-pin plastic TSOP (II) (400 mil) (Normal bent)

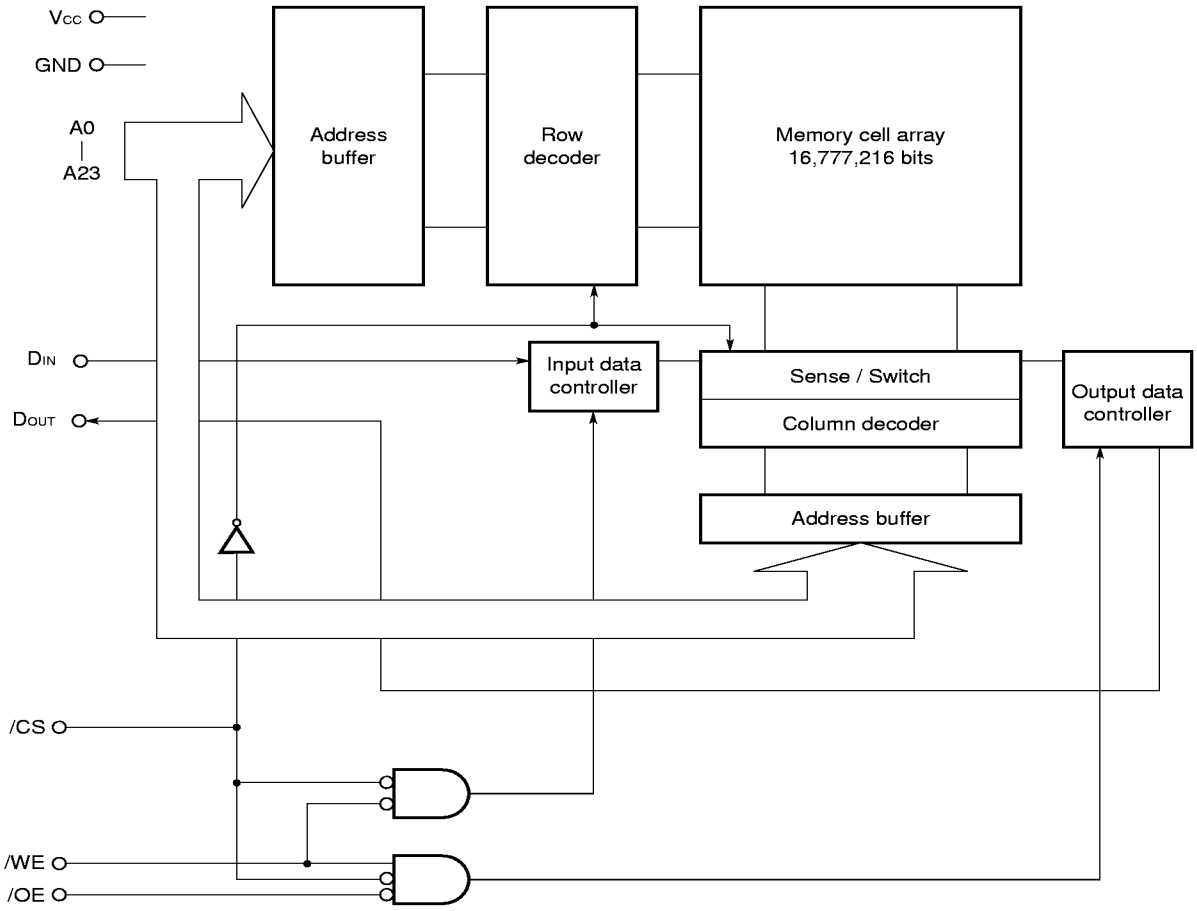
[μPD4416001G5–xxx–9JF]



A0 - A23	:	Address Inputs
D_{IN}	:	Data Input
D_{OUT}	:	Data Output
/CS	:	Chip Select
/WE	:	Write Enable
/OE	:	Output Enable
V_{CC}	:	Power supply
GND	:	Ground
NC	:	No connection
★ IC	:	Internal connection [Note]

Note Leave this pin connect to GND.

Block Diagram



Truth Table

/CS	/OE	/WE	Mode	I/O	Supply current
H	×	×	Not selected	High impedance	I_{SB}
L	L	H	Read	D_{OUT}	I_{CC}
L	×	L	Write	D_{IN}	
L	H	H	Output disable	High impedance	

Remark × : Don't care

Electrical Specifications

Absolute Maximum Ratings

	Parameter	Symbol	Condition		Rating	Unit
★	Supply voltage	V_{CC}		A version	–0.5 Note to +4.6	V
				C version	–0.5 Note to +3.0	
★	Input / Output voltage	V_T		A version	–0.5 Note to +4.6	V
				C version	–0.5 Note to +3.0	
	Operating ambient temperature	T_A			0 to +70	°C
	Storage temperature	T_{stg}			–55 to +125	°C

Note –2.0 V (MIN.) (pulse width : 2 ns)

Caution Exposing the device to stress above those listed in Absolute Maximum Rating could cause permanent damage. The device is not meant to be operated under conditions outside the limits described in the operational section of this specification. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.

Recommended Operating Conditions

(A version)

	Parameter	Symbol	Condition	MIN.	TYP.	MAX.	Unit
	Supply voltage	V_{CC}		3.0	3.3	3.6	V
★	High level input voltage	V_{IH}		2.0		V_{CC} + 0.3	V
	Low level input voltage	V_{IL}		–0.3 Note		+0.8	V
	Operating ambient temperature	T_A		0		70	°C

Note –2.0 V (MIN.) (pulse width : 2 ns)

(C version)

Parameter	Symbol	Condition	MIN.	TYP.	MAX.	Unit
Supply voltage	V_{CC}		2.375	2.5	2.625	V
High level input voltage	V_{IH}		1.7		V_{CC} + 0.3	V
Low level input voltage	V_{IL}		–0.3 Note		+0.7	V
Operating ambient temperature	T_A		0		70	°C

Note –2.0 V (MIN.) (pulse width : 2 ns)

DC Characteristics (Recommended Operating Conditions Unless Otherwise Noted)

	Parameter	Symbol	Test condition		MIN.	TYP.	MAX.	Unit
	Input leakage current	I_{LI}	V_{IN} = 0 V to V_{CC}		–2		+2	μA
	Output leakage current	I_{LO}	V_{OUT} = 0 V to V_{CC}, /CS = V_{IH} or /OE = V_{IH} or /WE = V_{IL}		–2		+2	μA
	Operating supply current	I_{CC}	/CS = V_{IL}, I_{OUT} = 0 mA, Minimum cycle time	Cycle time : 12 ns			190	mA
				Cycle time : 15 ns			150	
★	Standby supply current	I_{SB}	/CS = V_{IH}, V_{IN} = V_{IH} or V_{IL}, Minimum cycle time				80	mA
		I_{SB1}	V_{CC} – 0.2 V ≤ /CS, V_{IN} ≤ 0.2 V or V_{CC} – 0.2 V ≤ V_{IN}				10	
	3.3 V LVTTL Interface (A version)							
	High level output voltage	V_{OH}	I_{OH} = –4.0 mA		2.4			V
	Low level output voltage	V_{OL}	I_{OL} = +8.0 mA				0.4	V
	2.5 V LVTTL Interface (C version)							
★	High level output voltage	V_{OH}	I_{OH} = –2.0 mA		1.7			V
★			I_{OH} = –1.0 mA		2.0			
★	Low level output voltage	V_{OL}	I_{OL} = +2.0 mA				0.7	V
★			I_{OL} = +1.0 mA				0.4	

Remark V_{IN} : Input voltage, V_{OUT} : Output voltage

Capacitance (T_A = 25 °C, f = 1 MHz)

	Parameter	Symbol	Test condition	MIN.	TYP.	MAX.	Unit
	Input capacitance	C_{IN}	V_{IN} = 0 V			6	pF
★	Input / Output capacitance	C_{OUT}	V_{OUT} = 0 V			8	pF

Remarks 1. V_{IN} : Input voltage, V_{OUT} : Output voltage

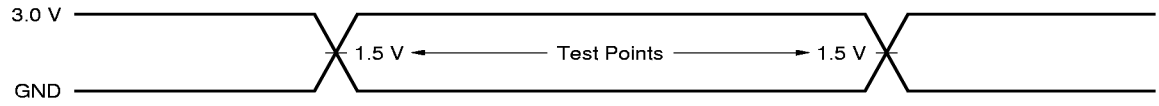
2. These parameters are periodically sampled and not 100% tested.

AC Characteristics (Recommended Operating Conditions Unless Otherwise Noted)

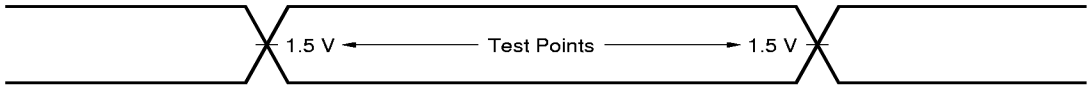
AC Test Conditions

3.3 V LVTTL Interface (A version)

Input Waveform (Rise and Fall Time ≤ 3 ns)



Output Waveform



Output Load

AC characteristics directed with the note should be measured with the output load shown in Figure 1 or Figure 2.

Figure 1

(for t_{AA}, t_{ACS}, t_{OE}, t_{OH})

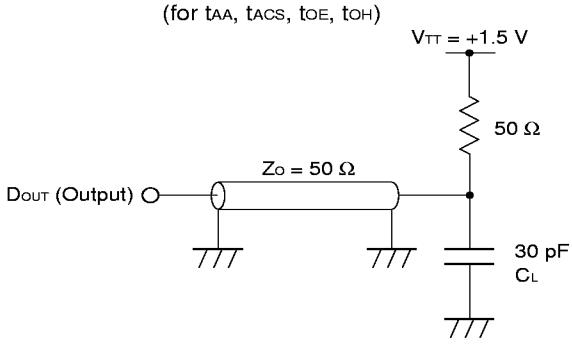
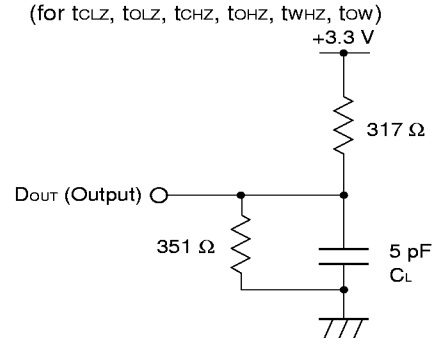


Figure 2

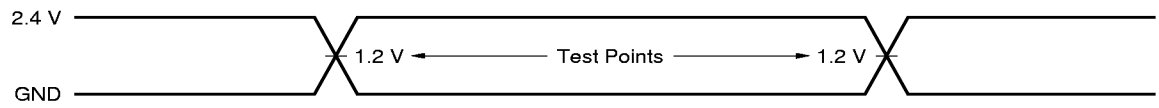
(for t_{CLZ}, t_{OLZ}, t_{CHZ}, t_{OHZ}, t_{WHZ}, t_{OW})



Remark C_L includes capacitances of the probe and jig, and stray capacitances.

2.5 V LVTTL Interface (C version)

Input Waveform (Rise and Fall Time ≤ 2.4 ns)



Output Waveform

Output Load

AC characteristics directed with the note should be measured with the output load shown in Figure 1 or Figure 2.

★ **Figure 3**

(for t_{AA}, t_{ACS}, t_{OE}, t_{OH})

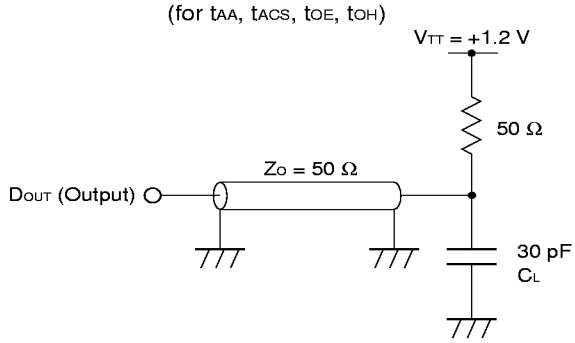
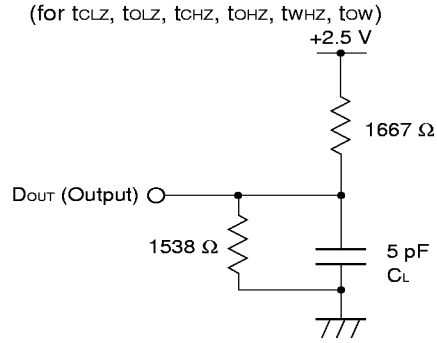


Figure 4

(for t_{CLZ}, t_{OLZ}, t_{CHZ}, t_{OHZ}, t_{WHZ}, t_{OW})



Remark C_L includes capacitances of the probe and jig, and stray capacitances.

Read Cycle

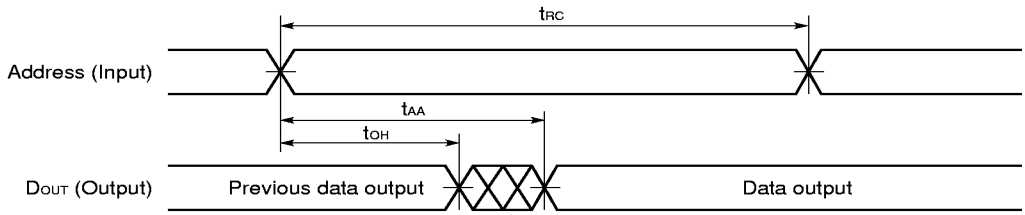
Parameter	Symbol	-A12		-A15		Unit	Notes
		MIN.	MAX.	MIN.	MAX.		
Read cycle time	t_{RC}	12		15		ns	
Address access time	t_{AA}		12		15	ns	1
/CS access time	t_{ACS}		12		15	ns	
/OE access time	t_{OE}		6		7	ns	
Output hold from address change	t_{OH}	3		3		ns	
/CS to output in low impedance	t_{CLZ}	3		3		ns	2, 3
/OE to output in low impedance	t_{OLZ}	0		0		ns	
/CS to output in high impedance	t_{CHZ}		6		7	ns	
/OE to output hold in high impedance	t_{OHZ}		6		7	ns	

Notes 1. See the output load shown in **Figure 1, 3**.

2. Transition is measured at ±200 mV from steady-state voltage with the output load shown in **Figure 2, 4**.

3. These parameters are periodically sampled and not 100% tested.

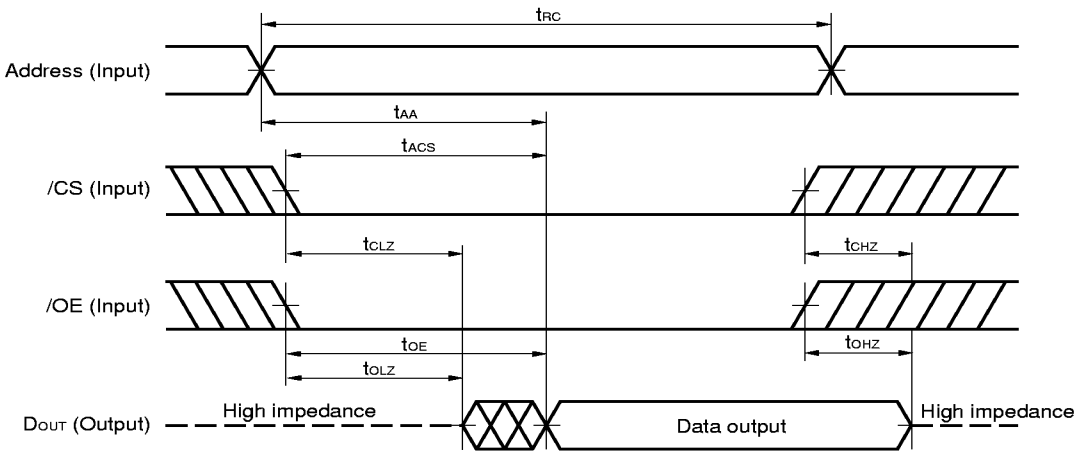
Read Cycle Timing Chart 1 (Address Access)



Remarks 1. In read cycle, /WE should be fixed to high level.

2. /CS = /OE = V_{IL}

Read Cycle Timing Chart 2 (/CS Access)



Caution Address valid prior to or coincident with /CS low level input.

Remark In read cycle, /WE should be fixed to high level.

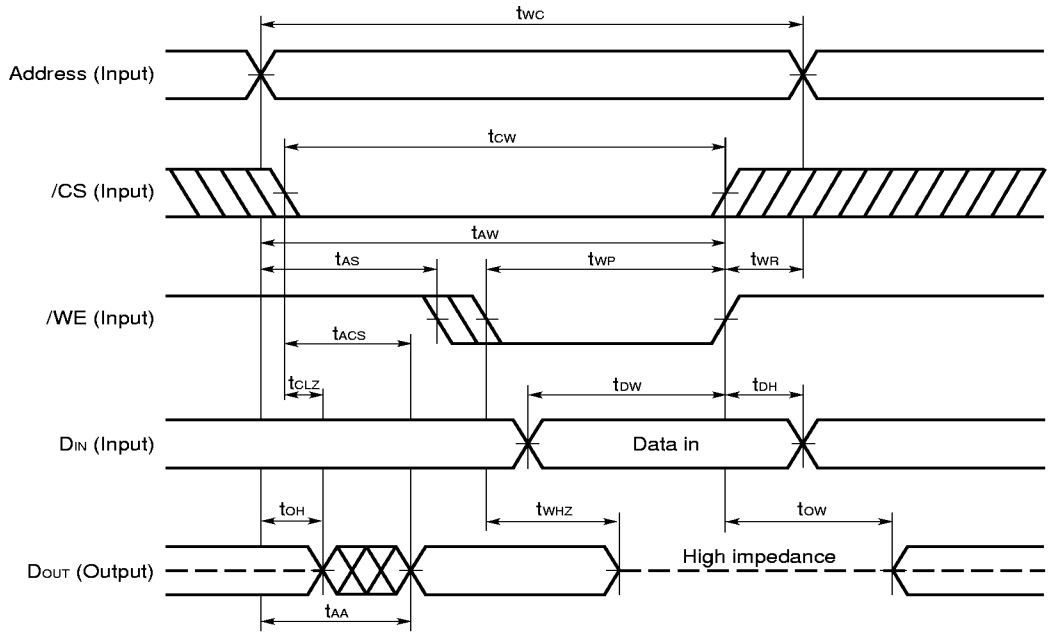
Write Cycle

Parameter	Symbol	-A12		-A15		Unit	Notes
		MIN.	MAX.	MIN.	MAX.		
Write cycle time	t_{WC}	12		15		ns	
/CS to end of write	t_{CW}	8		10		ns	
Address valid to end of write	t_{AW}	8		10		ns	
Write pulse width	t_{WP}	8		10		ns	
Data valid to end of write	t_{DW}	6		7		ns	
Data hold time	t_{DH}	0		0		ns	
Address setup time	t_{AS}	0		0		ns	
Write recovery time	t_{WR}	1		1		ns	
/WE to output in high impedance	t_{WHZ}		6		7	ns	1, 2
Output active from end of write	t_{OW}	3		3		ns	

Notes 1. Transition is measured at ± 200 mV from steady-state voltage with the output load shown in **Figure 2, 4**.

2. These parameters are periodically sampled and not 100% tested.

Write Cycle Timing Chart 1 (/WE Controlled)



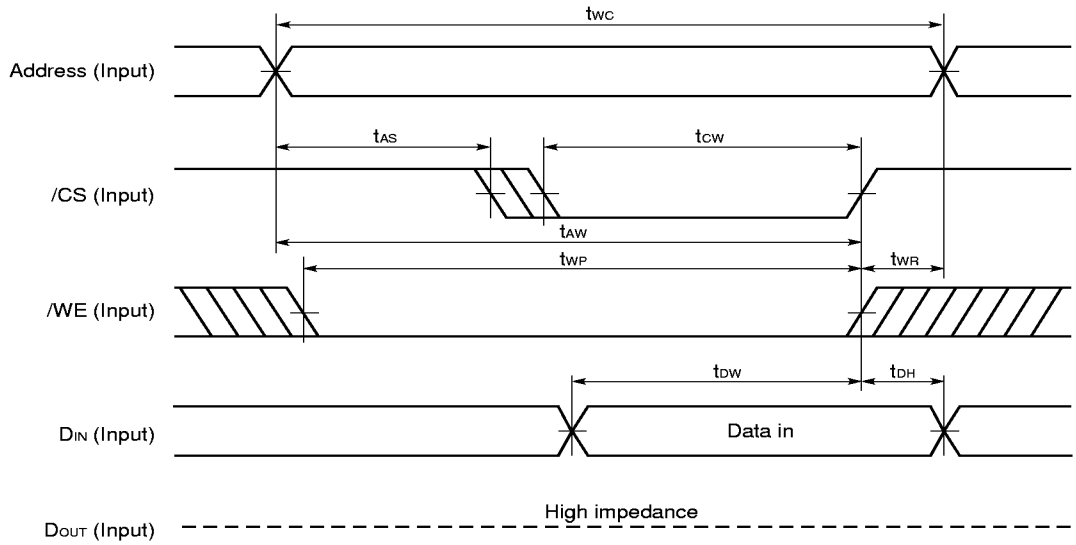
Caution /CS or /WE should be fixed to high level during address transition.

Remarks 1. Write operation is done during the overlap time of a low level /CS, a low level /WE.

2. During t_{WHZ}, D_{OUT} pins are in the output state, therefore the input signals of opposite phase to the output must not be applied.

3. When /WE is at low level, the D_{OUT} pins are always high impedance. When /WE is at high level, read operation is executed. Therefore /OE should be at high level to make the D_{OUT} pins high impedance.

Write Cycle Timing Chart 2 (/CS Controlled)

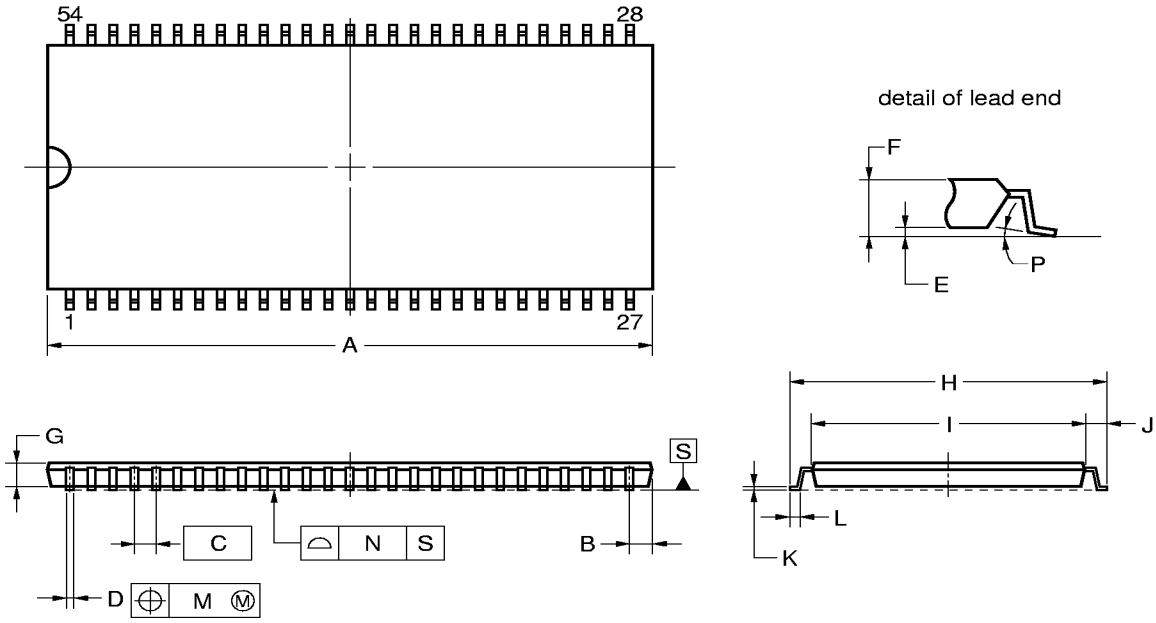


Caution /CS or /WE should be fixed to high level during address transition.

Remark Write operation is done during the overlap time of a low level /CS and a low level /WE.

Package Drawing

54PIN PLASTIC TSOP (II) (400mil)



NOTES

1. Each lead centerline is located within 0.13 mm of its true position (T.P.) at maximum material condition.
2. Dimension "A" does not include mold flash, protrusions or gate burrs. Mold flash, protrusions or gate burrs shall not exceed 0.15 mm per side.

ITEM	MILLIMETERS
A	22.22±0.05
B	0.91 MAX.
C	0.80 (T.P.)
D	$0.32^{+0.08}_{-0.07}$
E	0.10±0.05
F	1.1±0.1
G	1.00
H	11.76±0.20
I	10.16±0.10
J	0.80±0.20
K	$0.145^{+0.025}_{-0.015}$
L	0.50±0.10
M	0.13
N	0.10
P	$3°^{+7°}_{-3°}$

S54G5-80-9JF-1